

# Low VF SMD Schottky Barrier Diode

#### **FEATURES**

- Low power loss, high current capability, low VF
- Surface device type mounting
- Moisture sensitivity level (MSL): 1
- Matte Tin (Sn) lead finish with Nickel (Ni) under plate
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21









#### **MECHANICAL DATA**

- Case: SOD-123 small outline plastic package

- Molding compound, UL flammability classification rating 94V-0

 Terminal: Matte tin plated, lead free, solderable per MIL-STD-202, Method 208 guar
High temperature soldering guaranteed: 260°C/10s

Polarity: Indicated by cathode bandWeight: 0.01 g (approximately)

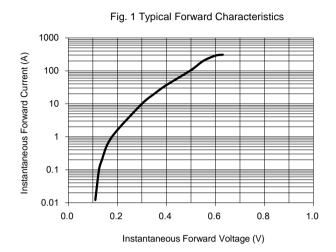
MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T <sub>A</sub> =25°C unless otherwise noted)					
PARAMETER	SYMBOL	SD103AW	SD103BW	SD103CW	UNIT
Power Dissipation	$P_D$		400		mW
Repetitive Peak Reverse Voltage	$V_{RRM}$	40	30	20	V
Reverse Voltage	$V_R$	28	21	14	V
Mean Forward Current @ T <sub>L</sub> = 100°C	Io		350		mA
Repetitive Peak Forward Surge Current $@t \le 1.0 \text{ s}$	I <sub>FRM</sub>		1.5		Α
Thermal Resistance ( Junction to Ambient )	$R_{\theta JA}$	300		°C/W	
Junction Temperature	$T_J$	125		°C	
Storage Temperature Range	T <sub>STG</sub>	-65 to +125			°C

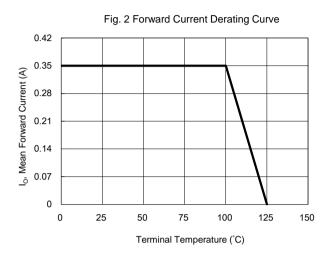
PARAM	SYMBOL	MIN	TYP	MAX	Units	
	SD103AW I <sub>R</sub> = 10 μA		40			
Reverse Breakdown Voltage	SD103BW $I_R = 10 \mu A$	$V_{(BR)}$	30	-	-	V
	SD103CW $I_R = 10 \mu A$		20			
Famurad Valtage	I <sub>F</sub> = 20 mA	V	-	-	0.37	V
Forward Voltage	$I_F = 200 \text{ mA}$	$V_{F}$			0.60	
	SD103AW V <sub>R</sub> = 30 V					
Reverse Leakage Current	SD103BW $V_R = 20 \text{ V}$	$I_R$	<b>-</b>	-	5	μA
	SD103CW $V_R = 10 \text{ V}$					
Junction Capacitance $V_R = 0$ , $f = 1.0 \text{ MHz}$		C <sub>J</sub>		50		pF

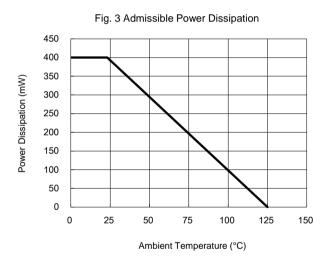


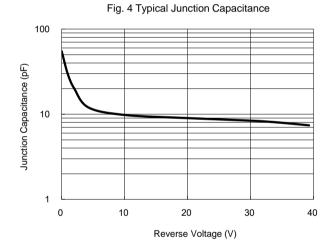
### **RATINGS AND CHARACTERISTICS CURVES**

(T<sub>A</sub>=25°C unless otherwise noted)













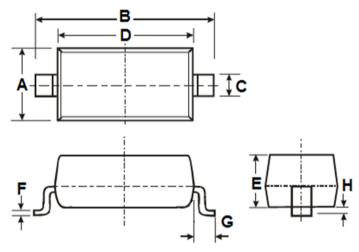
ORDERING INFORMATION				
PART NO.	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
SD103xW (Note 1, 2)	RH	G	SOD-123	3K / 7" Reel

Note 1: "x" is Device Code from "A" - "C". Note 2: Whole series with green compound

EXAMPLE				
EXAMPLE P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
SD103AW RHG	SD103AW	RH	G	Green compound

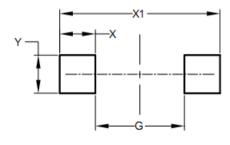
### **PACKAGE OUTLINE DIMENSIONS**

**SOD-123** 



DIM.	Unit (mm)		Unit (inch)	
DIIVI.	Min	Max	Min	Max
Α	1.40	1.80	0.055	0.071
В	3.55	3.85	0.140	0.152
С	0.45	0.70	0.018	0.028
D	2.55	2.85	0.100	0.112
Е	0.95	1.35	0.037	0.053
F	0.05	0.15	0.002	0.006
G	0.50 REF		0.02	REF
Н	- 0.10		-	0.004

## **SUGGEST PAD LAYOUT**



DIM.	Unit (mm)	Unit (inch)
DIIVI.	Min	Min
G	2.25	0.089
Х	0.90	0.035
X1	4.05	0.159
Υ	0.95	0.037

### **MARKING**

Part No.	Marking
SD103AW	S4
SD103BW	S5
SD103CW	S6





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